imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

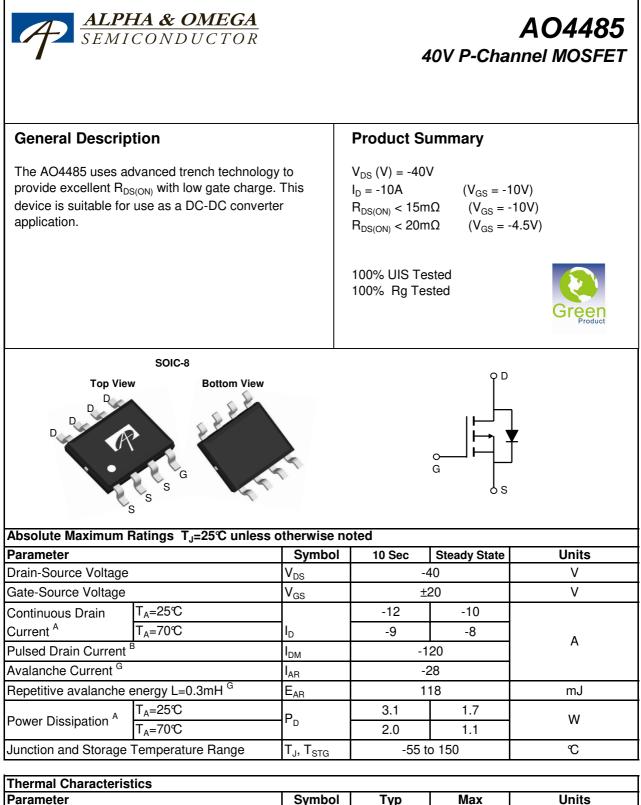
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Parameter		Symbol	Тур	Max	Units			
Maximum Junction-to-Ambient ^A	t ≤ 10s	$R_{ extsf{ heta}JA}$	31	40	C/W			
Maximum Junction-to-Ambient ^A	Steady State	ιι _θ jΑ	59	75	°C/W			
Maximum Junction-to-Lead ^C	Steady State	$R_{ extsf{ heta}JL}$	16	24	°C/W			

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC P	ARAMETERS					
BV _{DSS}	Drain-Source Breakdown Voltage	$I_{D} = -250 \mu A, V_{GS} = 0 V$	-40			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -40V, V_{GS} = 0V$			-1	
		T _J = 55°C			-5	μΑ
I _{GSS}	Gate-Body leakage current	$V_{DS} = 0V, V_{GS} = \pm 20V$			±100	nA
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS} I_D = -250 \mu A$	-1.7	-1.9	-2.5	V
I _{D(ON)}	On state drain current	$V_{GS} = -10V, V_{DS} = -5V$	-120			А
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = -10V, I_{D} = -10A$		12.5	15	
		T _J =125℃		19	23	mΩ
		$V_{GS} = -4.5V, I_D = -8A$		16	20	
g fs	Forward Transconductance	$V_{DS} = -5V, I_{D} = -10A$		25		S
V _{SD}	Diode Forward Voltage	$I_{\rm S} = -1A, V_{\rm GS} = 0V$		-0.7	-1	V
I _S	Maximum Body-Diode Continuous Cur			-3	Α	
DYNAMIC	PARAMETERS			-	-	-
C _{iss}	Input Capacitance			2500	3000	pF
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =-20V, f=1MHz		260		pF
C _{rss}	Reverse Transfer Capacitance			180		рF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	2.5	4	6	Ω
SWITCHI	NG PARAMETERS	- · · ·			-	
Q _g (10V)	Total Gate Charge			42	55	nC
Q _g (4.5V)	Total Gate Charge	V _{GS} =-10V, V _{DS} =-20V, I _D =-10A		18.6		nC
Q _{gs}	Gate Source Charge	$V_{GS} = -10V, V_{DS} = -20V, I_D = -10A$		7		nC
Q _{gd}	Gate Drain Charge			8.6		nC
t _{D(on)}	Turn-On DelayTime			9.4		ns
t _r	Turn-On Rise Time	V _{GS} =-10V, V _{DS} =-20V,		20		ns
t _{D(off)}	Turn-Off DelayTime	$R_L = 2\Omega, R_{GEN} = 3\Omega$		55		ns
t _f	Turn-Off Fall Time	7		30		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-10A, dl/dt=100A/μs		38	49	ns
Q _{rr}	Body Diode Reverse Recovery Charge	_e I _F =-10A, dI/dt=100A/μs		47		nC

Electrical Characteristics (T_J=25°C unless otherwise noted)

A: The value of R_{0JA} is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with T_A = 25°C. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\rm eJA}$ is the sum of the thermal impedence from junction to lead R $_{\rm eJL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using t \leqslant 300 μs pulses, duty cycle 0.5% max.

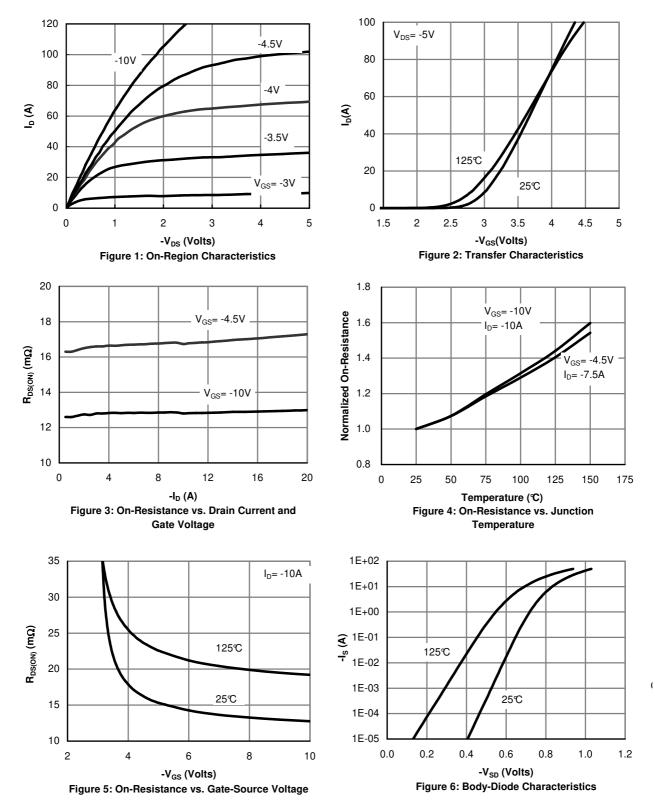
E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}$ C. The SOA curve provides a single pulse rating.

F. The current rating is based on the t \leqslant 10s thermal resistance rating.

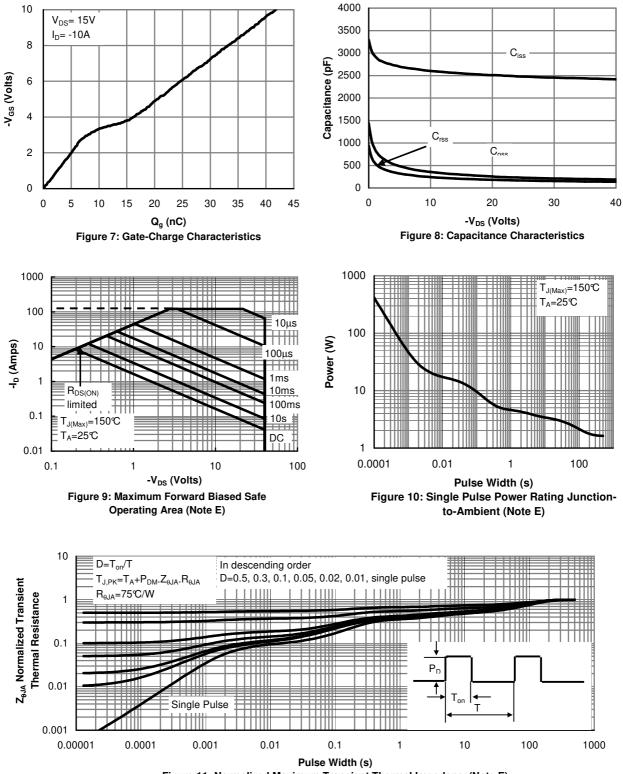
G. E_{AR} and I_{AR} ratings are based on low frequency and duty cycles to keep T_j=25C.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 11: Normalized Maximum Transient Thermal Impedance(Note E)

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